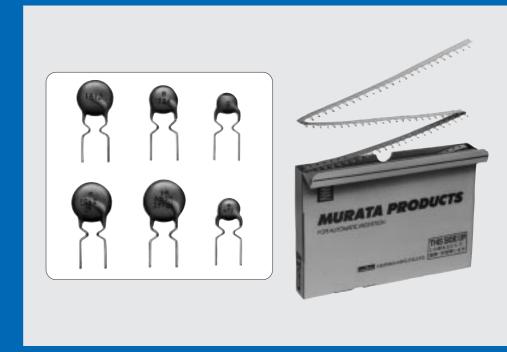


CERAMIC CAPACITORS





■CONTENT

■GENERAL DESCRIPTION OF CERAMIC CAPACITORS ····································	2
■MURATA'S DISC TYPE CERAMIC CAPACITORS ······	2
■MURATA'S CERAMIC CAPACITORS	
1. TABLE OF CAPACITANCE RANGE······	··3–4
2. PART NUMBERING	3–4
3. PRODUCT SPECIFICATIONS	
DD100 SERIES 50V CERAMIC CAPACITORS	5
DD10 SERIES 500V CERAMIC CAPACITORS	9
DD300/DD400 SERIES BC CAPACITORS	13
4. TAPING SPECIFICATIONS······	16
5. PACKAGING STYLES	16
6. SPECIFICATION AND TEST METHOD	
6-1. TEMPERATURE COMPENSATING TYPE DD100/DD10 SERIES	
6-2. HIGH DIELECTRIC CONSTANT TYPE DD100/DD10 SERIES	19
6-3. SEMICONDUCTIVE DIELECTRIC TYPE DD300/DD400 SERIES	21
7. TYPICAL CHARACTERISTICS DATA·····	
■ ⚠ CAUTION······	
■NOTICE	24
ISO9000 CERTIFICATIONS	24

■GENERAL DESCRIPTION OF CERAMIC CAPACITORS

Ceramic capacitors are produced by sandwiching a ceramic-dielectric layer of titanium oxide (TiO₂) or barium titanate (BaTiO₃) between two electrodes. Special features include high reliability, compact size, large capacitance, excellent high-frequency characteristics, and simple mass production. Furthermore, their low cost enables wide application in electronic circuits designed for by-pass, coupling, and resonant functions.

Ceramic capacitors are divided into two distinctive types according to structure ——— monolithic and disc type.

The latter type is available in a larger variety, with rated voltages of 50V, 250V, 500V, 1kV, 2kV, 3.15kV and 6.3kV, besides AC voltage. Murata has meanwhile developed its original BC capacitors ——— semiconductive ceramic capacitors which are much more compact in size and much larger in capacitance than conventional ceramic capacitors. BC capacitors are available in rated voltages of 12V, 16V, 25V and 50V.

■MURATA'S DISC TYPE CERAMIC CAPACITORS

	ISC TTPL CLKAN	/110	υ/ \ι	7101	1010	
DESCRIPTION	SERIES	TYPE			RATED	CAPACITANCE RANGE (pF)
DESCRIPTION	SERIES	1	2	3	VOLTAGE	1 10 100 1000 10000 100000 500000
CERAMIC CAPACITORS	DD100 DD10	0	0	_	50V 500V	1 47000
BC CAPACITORS	DD300 DD400	_	_	0	12V 16V 25V 50V	1000 470000
HIGH-VOLTAGE CERAMIC CAPACITORS	GENERAL HR	0	0	0	250V 500V 1kV 2kV 3.15kV 6.3kV	10 10000
SAFETY STANDARD RECOGNIZED CERAMIC CAPACITORS	KH KX AC250V	_	0	_	AC250V	100 10000

■MURATA'S CERAMIC CAPACITORS

1. TABLE OF CAPACITANCE RANGE

Carias	DC Rated Voltage (V)	Temp.	T	Nominal Capacitance Range (pF)				
Series		Voltage (V)	Char.	Туре	1 50 100 200 500 1000 2000 5000 10000 20000 50000 100000 20000 500000	Page		
		CΔ	1	1-270				
DD100	50	SL	'	1–1000	5-8			
DD 100	30	В	2	100-10000	3 0			
		F	2	2200-47000				
		СΔ	1	1-270				
DD10 500	500	500	SL		1–560	9-12		
	В	B 100-10000	100-10000					
		E			2	1000—10000		
	50	F		22000-100000				
DD300 /Surface\	25	F	3	22000-100000				
(layer	16			□ 220000	13-15			
	12			100000-470000	13 13			
DD400	25	SR	3	1000-100000				
(Boundary)	16	SR	3	10000-100000				

2. PART NUMBERING

(Please specify the part number when ordering.)



Type

Series	Code
DD100 DD300 DD400	DDXXX DD plus the first digit denotes the series; the next two digits denote nominal body diameter. (Example) DD1 06 Nominal Body Dia. 6mm DD100 Series
DD10	DDXX The two digits denote the nominal body diameter. (Example) DD 07 Nominal Body Dia. 7.5mm

2 Lead Configuration

Eead Comiguration			
Code	Configuration		
-63	Incido Crimo		
-64	Inside Crimp		
-959			
-989	Crimp Taping		
-999			

3 Temperature Characteristics

Code	Cap. Change or Temp. Coeff.	Temperature Range (℃)	
СК	0±250 (ppm/℃)		
CJ	0±120 (ppm/℃)	-25 to +85	
СН	0± 60 (ppm/°C)		
SL	+350 to −1000 (ppm/°C)	+20 to +85	
В	Within ±10%		
Е	Within +20%	25 to 1.95	
F	Within +30%	−25 to +85	
SR	Within ±15%		

Mominal Capacitance

The first two digits denote significant figures; the last digit denotes the multiplier of 10 in pF.

(Example)

472=47×10²=4700pF

Photo	Special Feature and Application Fields
	High reliability and low cost due to simple structure. Low residual inductance permits application at high frequency. The temperature-compensating type, in particular, is much more stable than conventional capacitors against temperature variations. The temperature-compensating type is applied mainly in oscillation, tuning, and coupling circuits; the high dielectric-constant type in decoupling and by-pass capacitors.
	Widely used in electronic circuits for TV and power sources.
	BC capacitors have been designed to be more compact in size than the conventional ceramic capacitors and are available at a lower cost. The series is divided into two types by structure surface-layer and boundary-layer. The surface-layer series can be used in the same way as the high dielectric-constant type of ceramic capacitors. The boundary-layer series can replace polyester-film capacitors because of similar characteristics.

6 Capacitance Tolerance

Code	Tolerance
С	±0.25pF
D	±0.5pF
J	± 5%
K	± 10%
M	± 20%
Р	+100 _/
Z	+ 80% - 20%

6 Rated Voltage

Code	DC Rated Voltage
12	12V
16	16V
25	25V
50	50V
500	500V



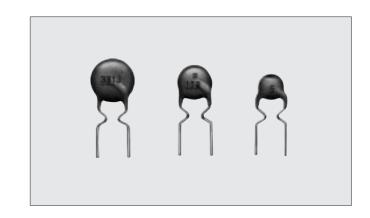
CERAMIC CAPACITORS



50V Ceramic Capacitors DD100 Series

■FEATURES

- 1. High reliability and low cost.
- 2. Little residual inductance. Can be used in the high frequencies.
- 3. Temperature compensating type with high Q and stable against temperature changes.
- 4. 50V-capacitors are designed to be suitable for 63V-applications.



■DIMENSIONS

Packaging form	Bulk	Taping*2
Configuration	Inside Crimp	Inside Crimp
Lead code	-63	-989, -999, -959
Dimensions (in mm)	Coating extension not exceed the center of crimp. 4.8 + 0.0	Lead spacing F: 5.0 Pitch of component P: 12.7 Pitch of sprocket hole Po: 12.7

^{*1 4.0} max. in the case of temperature compensating type of 22pF and under, and high dielectric constant type of 470pF and under.

■MARKING

Туре	Temperature Cor	mpensating Type	High Dielectric Constant Type		
Temp. Char.	CK, CJ, CH	SL	В	F	
DD104-DD106	12	(12)	(B)	472	
DD107 & DD108	121J	(331J)	(332K)	(223Z) M 67	
DD109-DD112	(271J) (M 67)	(561 J (M 67)	(B) (682K) [M 67]	(473Z) M 67	
Temperature Characteristics	Identified by color (Black).	Omitted.	Identified by code.	Omitted.	
Nominal Capacitance	Under 100pF : Actual value. 100pF and over : Identified by 3-figure code.				
Capacitance Tolerance	Identified by code. Omitted for Nom. Dia. \$\phi\$6mm and under except F103Z.				
Rated Voltage	Identified by horizontal line under capacitance.				
Manufacturer's Identification	Identified by M. Omitted for Nom. Dia. ∮8mm and under except F223Z.				
Manufactured Date	Abbreviation. Omitted for Nom. Dia. φ8mm and under except F223Z.				

^{*2} Please see page 16 on other taping specification.

■STANDARD LIST

Temperature Compensating Type	DD100 Series
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CK Characteristics (0±250ppm/°C)

CJ Characteristics (0±120ppm/°C) CH Characteristics (0± 60ppm/°C)

		ооррии о)			Lead	Code				
					Bulk	Taping				
Nominal	Body Dia.	Capacitance	DC Rated	Part Number	Inside Crimp	Crimp				
Capacitance (pF)	D (mm max.)	Tolerance	Voltage (V)	(: means optional lead code shown on the right.)						
1				DD104 □ CK 010 C 50						
1.5				DD104 □ CK 1R5 C 50						
2		10.05=5		DD104 □ CK 020 C 50						
3		±0.25pF		DD104 □ CJ 030 C 50						
4				DD104 □ CH 040 C 50						
5				DD104 □ CH 050 C 50						
6				DD104 □ CH 060 D 50						
7				DD104 □ CH 070 D 50						
8		±0.5pF		DD104 □ CH 080 D 50						
9	4			DD104 □ CH 090 D 50		-989				
10					DD104 □ CH 100 D 50		-969			
12				DD104 □ CH 120 J 50						
15				DD104 □ CH 150 J 50						
18			50	DD104 □ CH 180 J 50	-63					
22			30	DD104 □ CH 220 J 50	-03					
27				DD104 □ CH 270 J 50						
33								DD104 □ CH 330 J 50	1	
39				DD104 □ CH 390 J 50						
47				DD104 □ CH 470 J 50						
56	5	±5%		DD105 □ CH 560 J 50						
68	6			DD106 □ CH 680 J 50		– 999				
82	· ·			DD106 □ CH 820 J 50		_555				
100	7.5			DD107 □ CH 101 J 50						
120	7.5			DD107 □ CH 121 J 50						
150	8]		DD108 □ CH 151 J 50		- 959				
180	9.5			DD109 □ CH 181 J 50		-939				
220	5.5			DD109 □ CH 221 J 50						
270	10.5			DD110 □ CH 271 J 50						

Temperature Compensating Type DD100 Series

SL Characteristics (+350 to −1000ppm/°C)

SL Characte		1000	p		Lead	Code
					Bulk	Taping
Nominal	Body Dia.	Capacitance	DC Rated	Part Number	Inside Crimp	Crimp
Capacitance (pF)	D (mm max.)	Tolerance	Voltage (V)	(□: means optional lead code shown on the right.)		
1				DD104 □ SL 010 C 50		
1.5				DD104 □ SL 1R5 C 50		
2		10.05-5		DD104 □ SL 020 C 50		
3		±0.25pF		DD104 □ SL 030 C 50		
4				DD104 □ SL 040 C 50		
5				DD104 □ SL 050 C 50		
6				DD104 □ SL 060 D 50		
7				DD104 □ SL 070 D 50		
8		±0.5pF		DD104 □ SL 080 D 50		
9				DD104 □ SL 090 D 50		
10				DD104 □ SL 100 D 50		
12	4			DD104 □ SL 120 J 50		
15	4			DD104 □ SL 150 J 50		-989
18				DD104 □ SL 180 J 50		
22				DD104 □ SL 220 J 50		
27				DD104 □ SL 270 J 50		
33				DD104 □ SL 330 J 50		
39			50	DD104 □ SL 390 J 50	-63	
47				DD104 □ SL 470 J 50		
56				DD104 □ SL 560 J 50		
68				DD104 □ SL 680 J 50		
82				DD104 □ SL 820 J 50		
100		±5%		DD104 □ SL 101 J 50		
120		15%		DD104 □ SL 121 J 50		
150	5			DD105 □ SL 151 J 50		
180	6			DD106 □ SL 181 J 50		-999
220	<u> </u>			DD106 □ SL 221 J 50		
270				DD107 □ SL 271 J 50		
330	7.5			DD107 □ SL 331 J 50		
390				DD107 □ SL 391 J 50		
470	8			DD108 □ SL 471 J 50		-959
560	9.5			DD109 □ SL 561 J 50		
680	10.5			DD110 □ SL 681 J 50		
820	10.0			DD110 □ SL 821 J 50		
1000	12.5			DD112 □ SL 102 J 50		<u> </u>

High Dielectric Constant Type DD100 Series

B Characteristics (±10%)

					Lead	Code
Nominal	Body Dia.	Capacitance	DC Rated		Bulk	Taping
Capacitance	-	Tolerance	Voltage	Part Number	Inside Crimp	Crimp
(pF)	(mm max.)	(%)	(V)	(□ : means optional lead code shown on the right.)		
100				DD104 □ B 101 K 50		
120				DD104 □ B 121 K 50		
150				DD104 □ B 151 K 50		
180				DD104 □ B 181 K 50		
220				DD104 □ B 221 K 50		
270				DD104 □ B 271 K 50		
330				DD104 □ B 331 K 50		
390	4			DD104 □ B 391 K 50		– 989
470				DD104 □ B 471 K 50		-969
560				DD104 □ B 561 K 50		
680				DD104 □ B 681 K 50		
820				DD104 □ B 821 K 50		
1000		±10	50	DD104 □ B 102 K 50	-63	
1200				DD104 □ B 122 K 50		
1500				DD104 □ B 152 K 50		
1800	5			DD105 □ B 182 K 50		
2200	6			DD106 □ B 222 K 50		-999
2700	O			DD106 □ B 272 K 50		-999
3300				DD107 □ B 332 K 50		
3900	7.5			DD107 □ B 392 K 50		
4700				DD107 □ B 472 K 50		
5600	8			DD108 □ B 562 K 50		-959
6800	9.5			DD109 □ B 682 K 50		
8200	10.5			DD110 □ B 822 K 50		
10000	11			DD111 □ B 103 K 50		

F Characteristics (+30%)

				Lead Code		
Nominal Capacitance (pF)	,	Capacitance Tolerance (%)	DC Rated Voltage (V)	Part Number (□ : means optional lead code shown on the right.)	Bulk Inside Crimp	Taping Crimp
2200	4			DD104 □ F 222 Z 50		
4700	4		+80 -20 50	DD104 □ F 472 Z 50	-63	-989
6800	5	+80		DD105 □ F 682 Z 50		
10000	6	-20		DD106 □ F 103 Z 50		-999
22000	8			DD108 □ F 223 Z 50		050
47000	10.5			DD110 □ F 473 Z 50		- 959



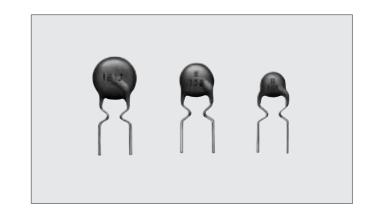
CERAMIC CAPACITORS



500V Ceramic Capacitors DD10 Series

■FEATURES

- 1. High reliability and low cost.
- 2. Little residual inductance. Can be used in the high frequencies.
- 3. Temperature compensating type with high Q and stable against temperature changes.



■DIMENSIONS

- BIIVIEI (GIGI				
Packaging form	Bulk	Taping*2		
Configuration	Inside Crimp	Inside Crimp		
Lead code	-63, -64	-989, -999, -959		
Dimensions (in mm)	Coating extension not exceed the center of crimp. 4.8 + 1.7 = 1.0	Lead spacing F: 5.0 Pitch of component P: 12.7 Pitch of sprocket hole Po: 12.7		

^{*1} F: 5.0 (Lead code: -63) or F: 10.0 (Lead code: -64)

■MARKING

Туре	Temperature Cor	mpensating Type	High Dielectric	Constant Type			
Temp. Char.	CK, CJ, CH	SL	В	E			
DD05 & DD06	10	10	(B)	(E)			
DD07 & DD08	33J	(181J)	B 122K	(E 222P)			
DD09-DD18	221J M 67	(561J) [M 67]	B 103K M 67	E 103P M 67			
Temperature Characteristics	Identified by color (Black).	Omitted.	Identified by code.	Identified by code.			
Nominal Capacitance	Under 100pF : Actual value	. 100pF and over : Identifie	ed by 3-figure code.				
Capacitance Tolerance	Identified by code. Omitted for Nom. Dia. \$\phi\$6mm and under.						
Rated Voltage	Omitted.						
Manufacturer's Identification	Identified by M. Omitted for Nom. Dia. ∮8mm and under.						
Manufactured Date	Abbreviation. Omitted for	Nom. Dia. ϕ 8mm and under	r				

^{*2} Please see page 16 on other taping specification.

■STANDARD LIST

Temperature Compensating Type	DD10 Series

CK Characteristics (0±250ppm/°C) CJ Characteristics (0±120ppm/°C) CH Characteristics (0± 60ppm/°C)

					Lead	Code												
					Bulk	Taping												
Nominal	Body Dia.	Capacitance	DC Rated	Part Number	Inside Crimp	Crimp												
Capacitance (pF)	D (mm max.)	Tolerance	Voltage (V)	(☐: means optional lead code shown on the right.)		0 0												
1				DD05 □ CK 010 C 500														
1.5				DD05 □ CK 1R5 C 500														
2		10.05.5		DD05 □ CK 020 C 500														
3		±0.25pF		DD05 □ CJ 030 C 500														
4				DD05 □ CH 040 C 500														
5				DD05 □ CH 050 C 500														
6				DD05 □ CH 060 D 500														
7				DD05 □ CH 070 D 500		-989												
8	5	±0.5pF		DD05 □ CH 080 D 500														
9		500				DD05 □ CH 090 D 500												
10				DD05 □ CH 100 D 500														
12						DD05 □ CH 120 J 500												
15																DD05 □ C	DD05 □ CH 150 J 500	-63
18				500	DD05 □ CH 180 J 500	_03												
22			500	DD05 □ CH 220 J 500														
27	6			DD06 □ CH 270 J 500		-999												
33				DD07 □ CH 330 J 500														
39	7.5			DD07 □ CH 390 J 500														
47				DD07 □ CH 470 J 500														
56	8	±5%		DD08 □ CH 560 J 500														
68	9.5			DD09 □ CH 680 J 500		-959												
82	9.5			DD09 □ CH 820 J 500														
100	10.5			DD10 □ CH 101 J 500	-													
120	0.01			DD10 □ CH 121 J 500														
150	11			DD11 □ CH 151 J 500														
180	12.5			DD12 □ CH 181 J 500														
220	14.5			DD14 □ CH 221 J 500	-64	_												
270	14.0			DD14 □ CH 271 J 500	04													

Temperature Compensating Type DD10 Series

SL Characteristics (+350 to -1000ppm/°C)

		0 10 1000p	<u> </u>		Lead	Code							
					Bulk	Taping							
Nominal	Body Dia.	Capacitance	DC Rated	Part Number	Inside Crimp	Crimp							
Capacitance (pF)	D (mm max.)	Tolerance	Voltage (V)	(: means optional lead code shown on the right.)									
1				DD05 □ SL 010 C 500									
1.5				DD05 □ SL 1R5 C 500									
2		10.05=5		DD05 □ SL 020 C 500									
3		±0.25pF		DD05 □ SL 030 C 500									
4				DD05 □ SL 040 C 500									
5				DD05 □ SL 050 C 500									
6				DD05 □ SL 060 D 500									
7				DD05 □ SL 070 D 500									
8		±0.5pF		DD05 □ SL 080 D 500									
9				DD05 □ SL 090 D 500									
10	5			DD05 □ SL 100 D 500		-989							
12				DD05 □ SL 120 J 500									
15				DD05 □ SL 150 J 500									
18							DD05 □ SL 180 J 500						
22													
27			500	DD05 □ SL 270 J 500	-63								
33			300	DD05 □ SL 330 J 500	-03								
39				DD05 □ SL 390 J 500									
47				DD05 □ SL 470 J 500									
56				DD05 □ SL 560 J 500									
68				DD05 □ SL 680 J 500									
82	6			DD06 □ SL 820 J 500		-999							
100	0	±5%		DD06 □ SL 101 J 500		333							
120	7.5	±370		DD07 □ SL 121 J 500									
150	1.0			DD07 □ SL 151 J 500									
180	8			DD08 □ SL 181 J 500									
220	9.5			DD09 □ SL 221 J 500		_959							
270	J.J			DD09 □ SL 271 J 500									
330	10.5			DD10 □ SL 331 J 500									
390	10.0			DD10 □ SL 391 J 500									
470	11			DD11 □ SL 471 J 500									
560	12.5			DD12 □ SL 561 J 500									

High Dielectric Constant Type DD10 Series

B Characteristics (±10%)

	151105 (=107				Lead	Code											
Nominal	Body Dia.	Capacitance	DC Rated		Bulk	Taping											
Capacitance	_	Tolerance	Voltage	Part Number	Inside Crimp	Crimp											
(pF)	(mm max.)	(%)	(V)	(□ : means optional lead code shown on the right.)													
100				DD05 □ B 101 K 500													
120				DD05 □ B 121 K 500													
150				DD05 □ B 151 K 500													
180				DD05 □ B 181 K 500													
220	_			DD05 □ B 221 K 500		– 989											
270	5			DD05 □ B 271 K 500		-969											
330				DD05 □ B 331 K 500													
390					DD05 □ B 391 K 500												
470					DD05 □ B 471 K 500												
560				DD05 □ B 561 K 500	-63												
680	6			DD06 □ B 681 K 500		-999											
820	0			DD06 □ B 821 K 500		-999											
1000	7.5	±10	500	DD07 □ B 102 K 500													
1200	7.5														DD07 □ B 122 K 500		
1500	8									DD08 □ B 152 K 500	-						
1800	0			DD08 B 182 K 500	-	- 959											
2200	9.5			DD09 □ B 222 K 500		-959											
2700	10.5			DD10 □ B 272 K 500													
3300	11			DD11 □ B 332 K 500													
3900	11	11		DD11 □ B 392 K 500													
4700	12.5			DD12 □ B 472 K 500													
5600	145			DD14 □ B 562 K 500													
6800	14.5			DD14 □ B 682 K 500	-64	<u> </u>											
8200	16.5			DD16 □ B 822 K 500	-04												
10000	18.5			DD18 □ B 103 K 500													

E Characteristics (+20/55%)

					Lead Code	
Nominal	Body Dia.	Capacitance	DC Rated		Bulk	Taping
Capacitance		Tolerance	Voltage	Part Number	Inside Crimp	Crimp
(pF)	(mm max.)	(%)	(V)	(□: means optional lead code shown on the right.)		
1000	6			DD06 □ E 102 P 500	-63	-999
1500	7.5			DD07 □ E 152 P 500		050
2200	8			DD08 □ E 222 P 500		
3300	9.5	+100 - 0	500	DD09 □ E 332 P 500		- 959
4700	10.5			DD10 □ E 472 P 500		
6800	12.5		-	DD12 □ E 682 P 500		
10000	14.5			DD14 □ E 103 P 500	-64	_



BC CAPACITORS

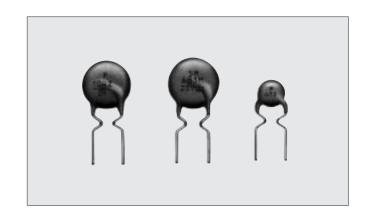


12/16/25/50V BC Capacitors DD300/DD400 Series

■FEATURES

Murata has devoted constant effort to developing semiconductive ceramics technology. We design capacitors in much more compact sizes than conventional ceramic capacitors, having reduced the diameter by 50% and the effective thickness by 90%. Capacitance values available are 0.001 to 0.47 μF , perfect for meeting the need for high density assemblies.

There are two kinds of BC capacitors, both designated by their inside construction ——— DD300 series (Surface layer type) and DD400 series (Boundary layer type).



■COMPARATIVE LIST OF EACH SERIES

Series	DD300 Series (Surface Layer)	DD400 Series (Boundary Layer)
Inside Construction and Equivalent Circuit	Surface Layer Electrode S Semiconductive Ceramics	Boundary Layer Electrode Semiconductive Ceramics

■DIMENSIONS

Packaging form	Bulk	Taping* ²
Configuration	Inside Crimp	Inside Crimp
Lead code	-63	-989, -999, -959
Dimensions (in mm)	Coating extension not exceed the center of crimp. 4.8 + 0.0	Lead spacing F: 5.0 Pitch of component P: 12.7 Pitch of sprocket hole Po: 12.7

 $^{\$1\,}$ 3.5mm max. in case of DD312

^{*2} Please see page 16 on other taping specification.

■MARKING

Series	DD300 Series				DD400 Series	
Temp. Char.	F			Temp. Char.	SR	
Rated Voltage Type	12V 16V 25V		50V	Rated Voltage Type	16V 25V	
DD304 DD305	F 473		F 223	DD404 DD405	SR 102M	
DD306	F 104Z 25V		F 473Z	DD406 DD407	SR 473M 25V	
DD308	DD308 (F 224Z 12VM)		F 104Z M	DD408	SR 683M 25VM	
DD310 DD312	F 334Z 12V M 67		D312 (334 <u>/</u> 12V M)		DD410	SR 104M 25V M 67
Temperature Characteristics	Identified by co	ode.		Identified by code		
Nominal Capacitance	Identified by 3	-figure code.		Identified by 3-figu	ıre code.	
Capacitance Tolerance	Identified by co	ode. om. Dia. ¢5mm and	under.	Identified by code		
Rated Voltage	12/16/25V	Identified by code. Omitted for Nom. I	Dia. φ5mm and under.	Identified by code. Omitted for Nom. Dia. \$\phi\$5mm and under.		
50V Indentified by horizontal line (–) under capacitance.		omitted for Nom.	Dia. yonini ana anaon.			
Manufacturer's Identification	Identified by M̄. Omitted for Nom. Dia. ∮6.3mm and under.			Identified by $\overline{\mathbb{M}}$. Omitted for Nom.	Dia. φ7mm and under.	
Manufactured Date	Abbreviation. Omitted for No	om. Dia. φ8mm and ι	under.	Abbreviation. Omitted for Nom.	Dia. φ8mm and under.	

[•] Marking of color : color of red

■STANDARD LIST

DD300 Series

F Characteristics (+30%)

F Character	ISTICS (±80%	6)					
	Nominal Body Dia. Cap				Lead Code		
Nominal			DC Rated		Bulk	Taping	
Capacitance		Capacitance Tolerance	Voltage	Part Number	Inside Crimp	Crimp	
(pF)	(mm)	(%)	(V)	(: means optional lead code shown on the right.)	\bigcirc	\circ	
	` '	, ,			X		
100000	5±1			DD305 □ F 104 Z 12		-999	
220000	8±1		12	DD308 □ F 224 Z 12		050	
330000	10±1		12	DD310 □ F 334 Z 12		– 959	
470000	12.5±1.3			DD312 □ F 474 Z 12			
220000	10±1		16	DD310 □ F 224 Z 16		-959	
22000				DD304 □ F 223 Z 25			
33000	4±1	+80 -20	25	DD304 □ F 333 Z 25	-63	-989	
47000				DD304 □ F 473 Z 25			
100000	6.3±1			DD306 □ F 104 Z 25		-959	
22000	4±1			DD304 □ F 223 Z 50		-989	
33000	5±1		50	DD305 □ F 333 Z 50		-999	
47000	6.3±1		50	DD306 □ F 473 Z 50		050	
100000	8±1			DD308 □ F 104 Z 50		– 959	

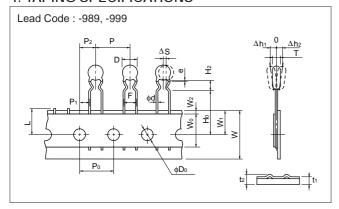
DD400 Series

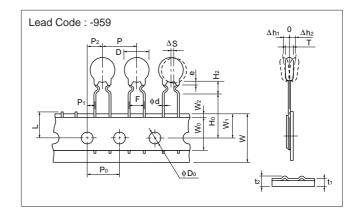
SR Characteristics (±15%)

SR Characte	· · ·				Lead	Code
					Bulk	Taping
Nominal	Body Dia.	Capacitance	DC Rated	Part Number	Inside Crimp	Crimp
Capacitance (pF)	D (mm)	Tolerance (%)	Voltage (V)	(□ : means optional lead code shown on the right.)	8	
10000				DD404 □ SR 103 M 16		
12000				DD404 □ SR 123 M 16		
15000	4±1			DD404 □ SR 153 M 16		-989
18000				DD404 □ SR 183 M 16		
22000				DD404 □ SR 223 M 16		
27000		1		DD405 □ SR 273 M 16		
33000			16	DD405 □ SR 333 M 16		
39000	5±1			DD405 □ SR 393 M 16		-999
47000				DD405 □ SR 473 M 16		
56000		1		DD406 □ SR 563 M 16		
68000	6.3±1			DD406 □ SR 683 M 16		
82000		1		DD407 □ SR 823 M 16		-959
100000	7±1			DD407 □ SR 104 M 16		
1000		-		DD404 □ SR 102 M 25		
1200				DD404 □ SR 122 M 25		
1500				DD404 □ SR 152 M 25		
1800				DD404 □ SR 182 M 25		
2200				DD404 □ SR 222 M 25		
2700		±20		DD404 □ SR 272 M 25	00	
3300				DD404 □ SR 332 M 25	-63	
3900	4±1			DD404 □ SR 392 M 25		-989
4700				DD404 □ SR 472 M 25		
5600				DD404 □ SR 562 M 25		
6800				DD404 □ SR 682 M 25		
8200				DD404 □ SR 822 M 25		
10000			25	DD404 □ SR 103 M 25		
12000				DD404 □ SR 123 M 25		
15000				DD404 □ SR 153 M 25		
18000	E 1.4]		DD405 □ SR 183 M 25		000
22000	5±1			DD405 □ SR 223 M 25		– 999
27000	6014]		DD406 □ SR 273 M 25		
33000	6.3±1			DD406 □ SR 333 M 25		
39000	714]		DD407 □ SR 393 M 25		
47000	7±1			DD407 □ SR 473 M 25		050
56000	014]		DD408 □ SR 563 M 25		- 959
68000	8±1			DD408 □ SR 683 M 25		
82000	1014]		DD410 □ SR 823 M 25		
100000	10±1			DD410 □ SR 104 M 25		

[•] Capacitance tolerance K (±10%) is also available.

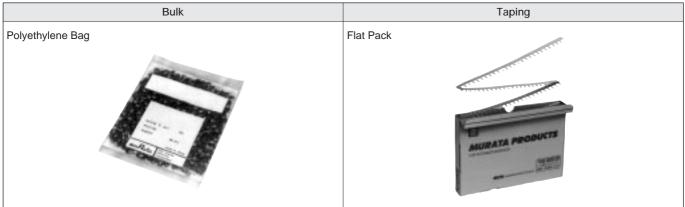
4. TAPING SPECIFICATIONS





Item	Code	Dimensions (mm)	Item	Code	Dimensions (mm)
Pitch of component	Р	12.7	Diameter of sprocket hole	φD ₀	4.0±0.1
Pitch of sprocket hole	Po	12.7±0.3	Lead diameter	φd	0.6+0.06
Lead spacing	F	5.0+0.8	Total tape thickness	t ₁	0.6±0.3
Length from hole center to component center	P ₂	6.35±1.3	Total thickness, tape and lead wire	t 2	1.5 max.
Length from hole center to lead	P ₁	3.85±0.7	Body thickness	Т	See the individual product specification
Body diameter	D	See the individual product specification	Deviation across tape	$\Delta h_1, \Delta h_2$	1.0 max.
Deviation along tape, left or right	ΔS	0±1.0	Portion to cut in case of defect	L	11.0 + 0.0
Carrier tape width	W	18.0±0.5	Hold down tape width	Wo	9.5 min.
Position of sprocket hole	W ₁	9.0±0.5	Hold down tape position	W ₂	1.5±1.5
		6.0 max. (-989)	Coating extension on lead	е	Up to the center of crimp
Lead distance between	H ₂	5.0 max. (-999)			
reference and bottom planes		4.8 max. (-959)			
F	H₀	16.0±0.5			

5. PACKAGING STYLES



■MINIMUM QUANTITY* (Order in Sets Only) [Bulk] 1,000 (pcs.) [Taping] 2,000 (pcs.)

■MINIMUM ORDER QUANTITY

10,000 (pcs.)

* "Minimum Quantity" means the numbers of units of each delivery or order. The quantity should be an integral multiple of the "minimum quantity".

(Please note that the actual delivery quantity in a package may change sometimes.)

6. SPECIFICATION AND TEST METHOD

6-1. TEMPERATURE COMPENSATING TYPE DD100/DD10 SERIES

	Iten		Specification	Testing Method
1	Operating Temp	erature Range	-25 to +85℃	
2	2 Capacitance		Within Specified tolerance.	The capacitance shall be measured at 20°C with 1±0.2MHz and AC5V (r.m.s.) max
3	Q		$C \ge 30pF : Q \ge 1000$ $C < 30pF : Q \ge 400+20C^{*1}$	Same condition as capacitance.
4	Insulation Resis	tance (I. R.)	10000MΩ min.	The insulation resistance shall be measured with DC10±1V (DC500±50V for DD10 Series) within 60±5 s of charging.
		Between lead wires	No failure.	The capacitor shall not be damage when DC voltage of 300% of the rated voltage are applied between the lead wires for 1 to 5 s. (Charge/discharge current≤50mA)
5	Dielectric Strength	Body Insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/discharge current≤50mA)
		Temperature	Within specified tolerance.	The capacitance measurement shall be made at each step
		Coefficient	(See Table A)	specified in table. Capacitance change from the value of
6	Temperature Characteristic Capacitance Drift Within ±0.2% is greater.	Within $\pm 0.2\%$ or ± 0.05 pF whichever is greater.	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	
		Appearance	No marked defect.	The capacitor shall firmly be soldered to the supporting lead
		Capacitance	Within specified tolerance.	wire and vibration which is 10 to 55Hz in the vibration
7	Vibration Resistance	Q	$C \ge 30pF : Q \ge 1000$ $C < 30pF : Q \ge 400+20C^{*1}$	frequency range. 1.5mm in total amplitude, and about 1 min in the rate of vibration change from 10Hz to 55Hz and back to 10Hz is applied for a total of 6 h; 2 h each in 3 mutually perpendicular directions.
		Appearance	No marked defect.	The lead wire shall be immersed into the melted solder of
	Coldoring	Capacitance Change	Within $\pm 2.5\%$ or ± 0.25 pF whichever is greater.	350±10℃ (Nominal body diameter ∮5mm and under 270±5℃) up to about 1.5 to 2mm from the main body for
8	Soldering Effect	Dielectric Strength (Between lead wires)	Pass the item No. 5.	3.5±0.5s. (Nominal body diameter \$\phi\$5mm and under 5±0.5s.) Post-treatment: Capacitor shall be stored for 1 to 2h at *2room condition.
		Appearance	No marked defect.	Set the capacitor for 500±24 h at 40±2℃ in 90 to 95%
	Humidity Under \ steady	Capacitance Change	Within ±5% or ±0.5pF whichever is greater.	relative humidity. Post-treatment : Capacitor shall be stored for 1 to 2 h at
9		Under \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		*2room condition.
	state	I. R.	1000MΩ min.	
	v state /	Dielectric Strength (Between lead wires)	Pass the item No. 5.	

Table A

Table	1						
Char.	Temp. Coeff. (ppm/°C) between +20°C and +85°C		Cap. Change (%) etween +20℃ and -25℃		Temp. Coeff. (ppm/℃) between +20℃ and +85℃		ange (%))℃ and −25℃
	between 120 c and 100 c	max.	min.			max.	min.
СК	0±250	1.54	-1.13	СН	0±60	0.49	-0.27
CJ	0±120	0.82	-0.54	SL	+350 to -1000	_	_

^{*1 &}quot;C" expresses nominal capacitance value (pF).
*2 "room condition" temperature : 15 to 35°C relative humidity : 45 to 75% atmospheric pressure : 86 to 106kPa

	Item	1	Specification		Testing Method			
		Appearance	No marked defect.	Apply the	rated voltage for 500 ⁺²⁴ ₀ h at	40±2℃ in 90 to 95%		
		Capacitance	Within ±7.5% or ±0.75pF	relative hu	umidity.			
		Change	whichever is greater.	Post-treat	Post-treatment : Capacitor shall be stored for 1 to			
		Q	$C \ge 30pF : Q \ge 200$ $C < 30pF : Q \ge 100 + \frac{10}{3}C^{*1}$	(0)	*²room condition. (Charge/discharge current≦50mA)			
10	Humidity	1.5		(Charge/d				
	Loading	I. R.	500MΩ min.	_				
		Dielectric Strength (Between lead wires)	Pass the item No. 5.					
		Appearance	No marked defect.	Apply a D	C voltage of 200% of the rated	d voltage for		
		Capacitance	Within ±3% or ±0.3pF	1000±48	h at 85±2℃.			
		Change	whichever is greater.	Post-treat	ment : Capacitor shall be store	ed for 1 to 2 h at		
			C ≥ 30pF : Q ≥ 350		*2room condition.			
		Q	10≦C<30pF: Q≥275+ 5/2 C*1	(Charge/c	lischarge current≦50mA)			
11	Life		C < 10pF : Q ≥ 200+10C*1					
		I. R.	2000MΩ min.					
		Dielectric						
		Strength (Between lead wires)	Pass the item No. 5.					
		Appearance	No marked defect.	The capa	citor shall be subjected to 5 cy	cles of temperature		
		Capacitance	Within ±5% or ±0.5pF	variation according to Table 1, then the capacitor shall be immersed into two baths, the one a clean water bath at				
		Change	whichever is greater.					
			C ≥ 30pF : Q ≥ 350	temperatu	temperature 65±5°C and the other a saturated salt water			
		Q	10≦C<30pF: Q≥275+ $\frac{5}{2}$ C*1	bath at te	bath at temperature 0±3°C for 15 min.			
			C < 10pF : Q ≥ 200+10C*1		This immersion cycle shall be repeated 2 times, then the			
		I. R.	1000MΩ min.		shall be washed in running wa	ater, wiped or dried		
12	Temperature and immersion			with air draught. Post-treatment : Capacitor shall be stored for 1 to 2 h at *2room condition.				
	cycling	Dielectric						
		Strength			(Table 1)			
		/Between \	Pass the item No. 5.	Step	Temperature (℃)	Time		
		lead wires		1	-25 ⁺⁰	30 min 3 min		
		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		3	room temp. 85±3	30 min		
				4				
					room temp. e, fix the body of capacitor, ap	3 min		
				tensile we	ight gradually to each lead wir	re in <i>!!(#!</i> }//		
		Pull		the radial	direction of capacitor up to 10	N N		
	Strength of		Lead wire shall not cut off.	and keep	it for 10±1 s.	wļ		
13	Lead		Capacitor shall not be broken.					
			Sapation of all flot be broken.		I wire shall be subjected to 5N	-		
		Bending			at the point of egress, in one			
		3		original position, and then a 90° bend in the opposite				
					at the rate of one bend in 2 to 3			
			Lead wire shall be soldered with		wire of a capacitor shall be dip			
14	Solderability of I	Leads	uniformly coated on the axial		f 25wt% rosin and then into mo			
			direction over $\frac{3}{4}$ of the		or 2±0.5 s. In both cases the			
"	0.11	l canacitance value (n	circumferential direction.	to about 1	.5 to 2 mm from the root of lea	au wires.		

^{*1 &}quot;C" expresses nominal capacitance value (pF).

*2 "room condition" temperature : 15 to 35°C relative humidity : 45 to 75% atmospheric pressure : 86 to 106kPa

6-2. HIGH DIELECTRIC CONSTANT TYPE DD100/DD10 SERIES

	Iten		Specification	Testing Method				
1	Operating Temperature Range		-25 to +85℃	———				
2	Capacitance		Within Specified tolerance.	The capacitance shall be measured at 20°C with 1±0.2kHz and AC5V (r.m.s.) max				
			B/E : D. F. ≦ 2.5%	Same condition as capacitance.				
3	Dissipation Fac	tor (D. F.)	F : D. F. ≦ 5.0%					
4	Insulation Resis	tance (I. R.)	$C^{*1} \le 0.02 \mu F$: $10000 M \Omega$ min. $C^{*1} > 0.02 \mu F$: $7500 M \Omega$ min.	The insulation resistance shall be measured with DC10±1V (DC500±50V for DD10 Series) within 60±5 s of charging.				
		Between lead wires	No failure.	The capacitor shall not be damage when DC voltage of 250% of the rated voltage are applied between the lead wires for 1 to 5 s. (Charge/discharge current ≤ 50mA)				
5	Dielectric Strength	Body Insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/discharge current≤50mA)				
		No DC voltage	B: Within ±10% E: Within ±20% F: Within ±30%	The capacitance measurement shall be made at each step specified in table and at a sufficient number of intermediate temperatures between step 2 and 7. Capacitance change from the value of step 3 shall not				
6	Characteristic With	aracteristic B · Within +10%		exceed the limit specified. Step 1 2 3 4 Temp. 20±2°C -25±3°C 20±2°C 85±2°C DC Voltage applied None None None None Step 5 6 7 8 Temp. 85±2°C 20±2°C -25±3°C 20±2°C DC Voltage applied Rated Rated Rated Rated Pre-treatment : Capacitor shall be stored at 85±2°C for 1 h, 7 1 </td				
	Vibration	Appearance Capacitance	No marked defect. Within specified tolerance.	then placed at *2 room condition for 24±2 h before measurements. The capacitor shall firmly be soldered to the supporting lead wire and vibration which is 10 to 55Hz in the vibration frequency range, 1.5 mm in total amplitude, and about 1 min				
7	Resistance	D. F.	Satisfies initial requirement.	frequency range. 1.5 mm in total amplitude, and about 1 r in the rate of vibration change from 10Hz to 55Hz and bat to 10Hz is applied for a total of 6 h; 2 h each in 3 mutually perpendicular directions.				
		Appearance	No marked defect.	The lead wire shall be immersed into the melted solder of				
		Capacitance	B: Within ± 5% E: Within ±15%	350±10℃ (Nominal body diameter ∮5mm and under 270±5℃) up to about 1.5 to 2mm from the main body for				
8	Soldering Effect	Dielectric Strength	F: Within ±20% Pass the item No. 5.	3.5±0.5s. (Nominal body diameter ∮5mm and under 5±0.5s. Pre-treatment: Capacitor shall be stored at 85±2℃ for 1 h, then placed at *²room condition for 24±2 h before initial measurements.				
		(Between lead wires)		Post-treatment : Capacitor shall be stored for 24±2 h at *2room condition.				
		Appearance	No marked defect.	Set the capacitor for 500±24 h at 40±2℃ in 90 to 95%				
		Capacitance Change	B: Within ±10% E: Within ±20% F: Within ±30%	relative humidity. Pre-treatment: Capacitor shall be stored at 85±2°C for 1 h, then placed at *2 room condition for 24±2 h				
	Humidity / Under \	D. F.	B/E: D. F. ≤ 5.0% F: D. F. ≤ 7.5%	before initial measurements. Post-treatment : Capacitor shall be stored for 1 to 2 h at				
9	steady state	I. R. Dielectric Strength (Between lead wires)	1000M Ω min. Pass the item No. 5.	*2room condition.				

^{*1 &}quot;C" expresses nominal capacitance value.

^{*2 &}quot;room condition" temperature : 15 to 35°C relative humidity : 45 to 75% atmospheric pressure : 86 to 106kPa

	Item	1	Specification		Testing Method		
	Appearance		No marked defect. B: Within ±10%	-1	rated voltage for 500±24 h at	40±2℃ in 90 to 95%	
		Capacitance Change	E: Within ±20% F: Within ±30%	relative humidity. Pre-treatment : Capacitor shall be s then placed at *2roo			
10	Humidity	D. F.	B/E: D. F. ≤ 5.0% F: D. F. ≤ 7.5%	Post-treat	before initial measurem ment : Capacitor shall be store		
	Loading	I. R.	500M Ω min.		*2room condition.		
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	(Charge/o	lischarge current≦50mA)		
		Appearance Capacitance Change	No marked defect. B: Within ±10% E: Within ±20% F: Within ±30%	1000±48	C voltage of 200% of the rated h at 85±2℃. nent: Capacitor shall be store then placed at *2room or	d at 85±2℃ for 1 h,	
11	Life	D. F.	B/E : D. F. ≤ 4.0% F : D. F. ≤ 7.5%	Post-treat	before initial measurem ment: Capacitor shall be store	ents.	
		I. R. Dielectric Strength	2000MΩ min.	(Charge/c	*²room condition. lischarge current≦50mA)		
		(Between) lead wires)	Pass the item No. 5.				
		Appearance	No marked defect.		citor shall be subjected to 5 cy	•	
		Capacitance Change B: Within ±10% E: Within ±20% F: Within ±30%		variation according to Table 1, then the capacitor shall be immersed into two baths, the one a clean water bath at temperature 65^{+5}_{-0} °C and the other a saturated salt water			
		D. F.	B/E : D. F. ≤ 5.0% F : D. F. ≤ 7.5%	bath at temperature 0±3°C for 15 min. This immersion cycle shall be repeated 2 times, then the			
		I. R.	1000MΩ min.	capacitor	shall be washed in running wa	ater, wiped or dried	
12	Temperature and immersion cycling	Dielectric Strength		with air draught. Pre-treatment: Capacitor shall be stored at 85±2°C for 1 h, then placed at *2room condition for 24±2 h before initial measurements. Post-treatment: Capacitor shall be stored for 24±2 h at *2room condition.			
		(Between	Pass the item No. 5.	Chara	(Table 1)	T'	
		\ lead wires/		Step 1	Temperature (°C) -25 ⁺ ₃	Time 30 min	
				2	room temp.	3 min	
				3 4	85±3 room temp.	30 min 3 min	
13	Strength of	Pull	Lead wire shall not cut off.	tensile we	e, fix the body of capacitor, ap eight gradually to each lead wind direction of capacitor up to 10 it for 10±1 s.	ply a re in	
	Lead	Bending	Capacitor shall not be broken.	Each lead wire shall be subjected to 5N weight and then a 90° bend, at the point of egress, in one direction, return to original position, and then a 90° bend in the opposite direction at the rate of one bend in 2 to 3 s.			
14	14 Solderability of Leads		Lead wire shall be soldered with uniformly coated on the axial direction over $\frac{3}{4}$ of the circumferential direction.	direction at the rate of one bend in 2 to 3 s. The lead wire of a capacitor shall be dipped into a methanol solution of 25wt% rosin and then into molten solder of 235±5°C for 2±0.5 s. In both cases the depth of dipping is up to about 1.5 to 2 mm from the root of lead wires.			

^{*2 &}quot;room condition" temperature : 15 to 35°C relative humidity : 45 to 75% atmospheric pressure : 86 to 106kPa

6-3. SEMICONDUCTIVE DIELECTRIC TYPE DD300/DD400 SERIES

0-3	Iten		C TYPE DD300/DD400 SERIES	Tooting Mathed
1			Specification -25 to +85°C	Testing Method
		crature Kariye		——— The capacitance shall be measured at 20°C with 1±0.2kHz
2	Capacitance		Within Specified tolerance.	and AC0.1V (r.m.s.) max (SR : AC1.0V (r.m.s.) max)
3	Dissipation Fac	tor (D. F.)	F:D.F. ≤ 5.0% SR:D.F. ≤ 2.5% (16V) D.F. ≤ 1.0% (25V)	Same condition as capacitance.
4	Insulation Resis	tance (I. R.)	F: 5MΩ • μF min. SR: 100MΩ min. (16V) 1000MΩ or 20MΩ • μF min. whichever is smaller. (25V)	The insulation resistance shall be measured with DC10±1V within 60±5 s of charging.
		Between lead wires	No failure.	The capacitor shall not be damage when DC voltage of 250% of the rated voltage are applied between the lead wires for 1 to 5 s.(Charge/discharge current≦10mA)
5	Dielectric Strength Body Insulation		No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/discharge current≤10mA)
		No DC voltage	F: Within ±30% SR: Within ±15%	The capacitance measurement shall be made at each step specified in table and at a sufficient number of intermediate temperatures between step 2 and 7. Capacitance change from the value of step 3 shall not exceed the limit specified.
6	Temperature Characteristic	With DC voltage	F: Within $^{+30}_{-95}\%$ SR: Within $^{+15}_{-30}\%$	Step 1 2 3 4 Temp. 20±2°C −25±3°C 20±2°C 85±2°C DC Voltage applied None None None None Step 5 6 7 8 Temp. 85±2°C 20±2°C −25±3°C 20±2°C DC Voltage applied ½ Rated ½ Rated ½ Rated ½ Rated Pre-treatment : Capacitor shall be stored at 125±3°C for 1 h, then placed at *room condition for 24±2 h before measurements.
		Appearance	No marked defect.	The capacitor shall firmly be soldered to the supporting lead
7	Vibration Resistance	D. F.	Within specified tolerance. Satisfies initial requirement.	wire and vibration which is 10 to 55Hz in the vibration frequency range. 1.5mm in total amplitude, and about 1 min in the rate of vibration change from 10Hz to 55Hz and back to 10Hz is applied for a total of 6 h; 2 h each in 3 mutually perpendicular directions.
		Appearance	No marked defect.	The lead wire shall be immersed into the melted solder of
		Capacitance	F: Within ±20%	350±10℃ (Nominal body diameter ∮4mm 270±5℃) up to
		Change	SR : Within ± 5%	about 1.5 to 2mm from the main body for 3.5±0.5 s. (Nominal
		D. F.	Satisfies initial requirement.	body diameter \$\phi4mm 5\pm 0.5 s.)
		I. R.	Satisfies initial requirement.	Pre-treatment: Capacitor shall be stored at 125±3°C for 1 h,
8	8 Soldering Effect	Dielectric Strength (Between (lead wires)	Pass the item No. 5.	then placed at *room condition for 24±2 h before measurements of capacitance and D. F. Post-treatment: Capacitor shall be stored for 24±2 h at *room condition. Measurement Order: I. R. • Dielectric Strength→Pre-treatment →Capacitance • D. F.→Soldering Effect test→Post-treatment→ Capacitance • D. F. • I. R. • Dielectric Strength
		Appearance	No marked defect.	Set the capacitor for 500±2 ⁴ / ₀ h at 40±2 [∞] in 90 to 95%
		Capacitance Change	F: Within ±20%	relative humidity.
	Llumai elite	_	SR: Within ±10% F: D. F. ≤ 7.5% SR: D. F. ≤ 4.0% (16V)	Pre-treatment: Capacitor shall be stored at 125±3°c for 1 h, then placed at *room condition for 24±2 h before
	Humidity / Under \	D. F.	D. F. ≤ 1.5% (25V)	measurements of capacitance and D. F.
9	steady state	I. R.	F: Satisfies initial requirement. SR: 1/2 of initial requirement or over.	Post-treatment : Capacitor shall be stored for 1 to 2 h at *room condition.
		Dielectric Strength Between	Pass the item No. 5.	Measurement Order: I. R. • Dielectric Strength→Pre-treatment →Capacitance • D. F.→Humidity test →Post-treatment→Capacitance •
		lead wires	plative humidity: 45 to 75% atmospheric press	D. F. • I. R. • Dielectric Strength

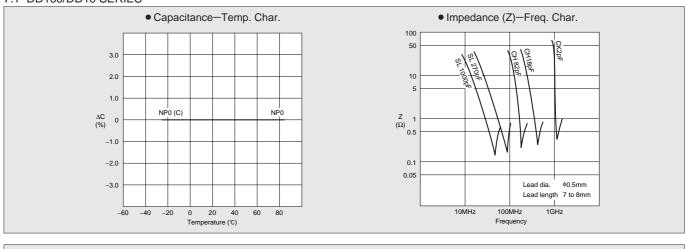
^{* &}quot;room condition" temperature : 15 to 35°C relative humidity : 45 to 75% atmospheric pressure : 86 to 106kPa

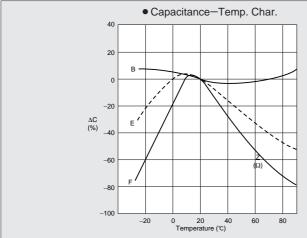
	Item	1	Specification	Testing Method		
		Appearance	No marked defect.	Apply the rated voltage for 500±20 h at 40±2℃ in 90 to 950		
		Capacitance	F: Within ±20%	relative humidity.		
		Change	SR : Within ±10%	Pre-treatment and Post-treatment :		
10	Humidity	D. F.	F: D. F. ≦ 7.5% SR: D. F. ≦ 4.0% (16V) D. F. ≦ 1.5% (25V)	Capacitor shall be stored at 125±3℃ for 1 h, then placed *room condition for 24±2 h before measurements of capacitance and D. F.		
10	Loading	I. R.	F: Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.	Measurement Order : I. R. • Dielectric Strength→Pre-treatment →Capacitance •		
		Dielectric		D. F.→Humidity Loading test →I. R. • Dielectric Strength*		
		Strength (Between lead wires)	Pass the item No. 5.	→Post-treatment→Capacitance • D. F. (Charge/discharge current≦10mA)		
		Appearance	No marked defect.	Apply a DC voltage of 150% of the rated voltage for		
		Capacitance	F: Within ±20%	1000 ^{±48} ₀ h at 85±2℃.		
	1 Life	Change	SR : Within ±10%	Pre-treatment and Post-treatment:		
11		D. F.	F: D. F. ≦ 7.5% SR: D. F. ≦ 4.0% (16V) D. F. ≦ 1.5% (25V)	Capacitor shall be stored at 125±3℃ for 1 h, then placed *room condition for 24±2 h before measurements of capacitance and D. F.		
' '	LIIC	I. R.	F : Satisfies initial requirement.	Measurement Order:		
		1. 13.	SR: $\frac{1}{2}$ of initial requirement or over.	I. R. • Dielectric Strength→Pre-treatment →Capacitance •		
		Dielectric Strength (Between) lead wires	Pass the item No. 5.	D. F.→Life test →I. R. • Dielectric Strength* →Post- treatment →Capacitance • D. F. (Charge/discharge current≦10mA)		
		Appearance	No marked defect.	The capacitor shall be subjected to 5 cycles of temperature		
		Capacitance Change	F: Within ±20% SR: Within ±10%	variation according to Table 1, then the capacitor shall be immersed into two baths, the one a clean water bath at		
		D. F.	F: D. F. ≦ 7.5% SR: D. F. ≦ 4.0% (16V) D. F. ≦ 1.5% (25V)	temperature 65±6°C and the other a saturated salt water bath at temperature 0±3°C for 15 min. This immersion cycle shall be repeated 2 times, then the capacitor shall be washed in running water, wiped or dried with air draught.		
		I. R.	F: Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.			
12	Temperature and immersion cycling	emperature nd immersion		Pre-treatment: Capacitor shall be stored at 125±3°C for 1 h then placed at *room condition for 24±2 h before measurements of capacitance and D. F. Post-treatment: Capacitor shall be stored for 24±2 h at *room condition. Measurement Order: I. R. • Dielectric Strength→Pre-treatment →Capacitance • D. F.→Temperature and Immersion cycling test →Post- treatment →Capacitance • D. F. • I.R. • Dielectric Strength (Table 1) Step Temperature (°C) Time		
				1 -25 ⁺⁰ ₋₃ 30 min		
				2 room temp. 3 min		
				3 85 ⁺³ 30 min		
				4 room temp. 3 min		
13			Lead wire shall not cut off. Capacitor shall not be broken.	As a figure, fix the body of capacitor, apply a tensile weight gradually to each lead wire in the radial direction of capacitor up to 10N and keep it for 10±1 s.		
Lodd	Bending		Each lead wire shall be subjected to 5N weight and then a 90° bend, at the point of egress, in one direction, return to original position, and then a 90° bend in the opposite direction at the rate of one bend in 2 to 3 s.			
			Lead wire shall be soldered with	The lead wire of a capacitor shall be dipped into a methano		
14	Solderability of L	eads	uniformly coated on the axial	The lead wire of a capacitor shall be dipped into a methano solution of 25wt% rosin and then into molten solder of		
14	Solderability of I	_eads		The lead wire of a capacitor shall be dipped into a methano		

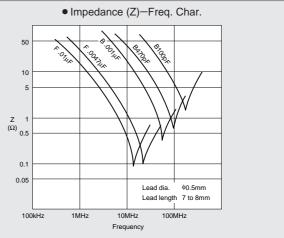
^{* &}quot;room condition" temperature: 15 to 35℃ relative humidity: 45 to 75% atmospheric pressure: 86 to 106kPa
The measurement of I. R. and Dielectric Strength will be held in 1 to 2 h after Humidity Loading test and in 24±2 h after Life test.

7. TYPICAL CHARACTERISTICS DATA

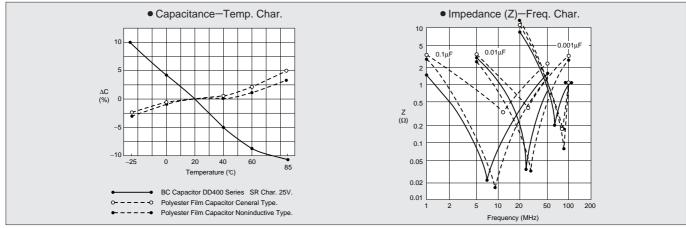
7.1 DD100/DD10 SERIES

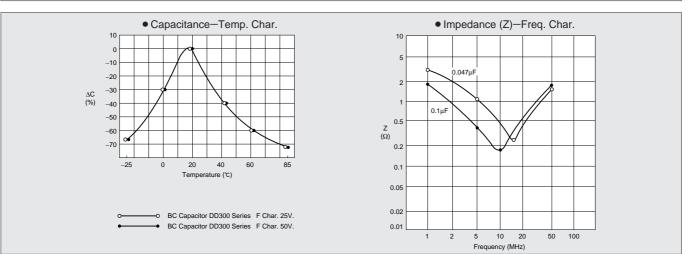






7.2 DD300/DD400 SERIES





■ **△** CAUTION

1. Operating voltage

When DC-rated capacitors are to be used in AC or ripple current signal circuits, be sure to maintain the Vp-p value of the applied voltage signal or the Vo-p which contains DC bias within the rated voltage range.

 Operating temperature and self-generated heat Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency circuit, pulse signal circuit or the like, it may have the self-generated heat due to dielectric-loss. Applied voltage should be the load such as self-generated heat is within 20°C on the condition of atmosphere temperature 25°C. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

3. Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment.

Store the capacitors where the temperature and relative humidity do not exceed 5 to 40° C and 20 to 70%. Use capacitors within 6 months.

4. Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

5 Soldering

When soldering this product to a PC board, do not exceed the solder heat resistance specification of the capacitor.

Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

Failure to follow the above cautions may result, worst case, in a short circuit and fuming when the product is used.

■NOTICE

1. Cleaning (Ultrasonic cleaning)

To perform ultrasonic cleaning, observe the following conditions

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 minutes max..

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue

destruction of the lead wires.

■ISO9000 CERTIFICATIONS

Manufacturing plants of these products in this catalog have obtained the ISO9000 quality system certificate.

Plant	Certified Date	Organization	Registration No.	Applied standard
Izumo Murata Manufacturing Co., Ltd.	Jul. 25. '97	Under Writers Laboratories Inc.	A5587	ISO9001
Murata Electronics (Thailand), Ltd.	Mar. 17. '98	Under Writers Laboratories Inc.	A6279	ISO9001

⚠ Note:

1. Export Control

(For customers outside Japan)

Murata products should not be used or sold for use in the development, production, stockpiling or utilization of any conventional weapons or mass-destructive weapons (nuclear weapons, chemical or biological weapons, or missiles), or any other weapons.

(For customers in Japan)

For products which are controlled items subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required for export.

- 2. Please contact our sales representatives or product engineers before using our products listed in this catalog for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property, or when intending to use one of our products for other applications than specified in this catalog.
 - Aircraft equipment
 - 2 Aerospace equipment
 - ③ Undersea equipment
 - 4 Power plant equipment
 - ⑤ Medical equipment
 - (6) Transportation equipment (vehicles, trains, ships, etc.)
 - 7 Traffic signal equipment
 - ® Disaster prevention / crime prevention equipment
 - Data-processing equipment
 - Application of similar complexity and/or reliability requirements to the applications listed in the above
- 3. Product specifications in this catalog are as of April 2000. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before your ordering. If there are any questions, please contact our sales representatives or product engineers.
- 4. The parts numbers and specifications listed in this catalog are for information only. You are requested to approve our product specification or to transact the approval sheet for product specification, before your ordering.
- 5. Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or third party's intellectual property rights and other related rights in consideration of your using our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
- 6. None of ozone depleting substances (ODS) under the Montreal Protocol is used in manufacturing process of us.



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